

SF1177A

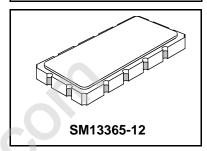
- Designed for Wide Channel IF Filtering
- Low Insertion Loss
- Hermetic 13.3 x 6.5 mm Surface-mount Case
- Balanced or Single Ended Input and Output
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

| Rating | Value | Units | |
|---|----------------|-------|--|
| Maximum Incident Power in Passband | +13 | dBm | |
| Max. DC voltage between any 2 terminals | 30 | VDC | |
| Storage Temperature Range | -40 to +85 | °C | |
| Suitable for lead-free soldering - Max. Soldering Profile | 260°C for 30 s | | |

57.6 MHz **SAW Filter**



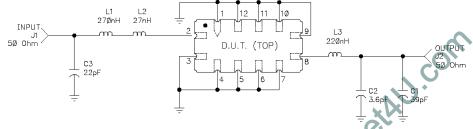
Electrical Characteristics

| Characteristic | | Sym | Notes | Min | Тур | Max | Units |
|--------------------------------------|--------------|------------------|---------|------|------|------|-------|
| Nominal Frequency | | f _N | 1 | | 57.6 | | MHz |
| Passband bandwidth | 1dB | B _W | | 21.2 | | | MHz |
| Insertion Loss | 47 68.2 MHz | 1 _L | 1 22 | | | 15.0 | dB |
| Rel. Attenuation to a _{max} | 0 29.8 MHz | | 1, 2,3 | 45 | | | |
| | 85.4 250 MHz | a _{rel} | | 45 | | | dB |
| | 250 1000 MHz | | | 35 | | | |
| Amplitude ripple (p-p) | 47 68.2 MHz | Δα | 400 | | | 1.5 | dB |
| Group delay ripple (p-p) | 47 68.2 MHz | Δτ | 1, 2, 3 | | | 50 | ns |
| 1 dB compression | 47 68.2 MHz | | | 12 | | | dBm |
| Input IP3 | 47 68.2 MHz | | | 30 | | | dBm |
| Max. Input level (non-destructive) | | | | 13 | | | dBm |
| Operating Temperature | | | 1 | -25 | | +85 | °C |
| Terminating source impedance | | | | | 50 | | Ohm |
| Terminating load impedance | | | | | 50 | | Ohm |

| Impedance Matching to 50 Ω Unbalanced | External L-C |
|--|--|
| Case Style | SM13365-12 13.3 x 6.5 mm Nominal Footprint |
| Lid Symbolization (YY = year, WW = week) | RFM SF1177A YYWW |

Electrical Connections

| 2 |
|------------|
| _ |
| 8 |
| All others |
| |



- Notes:

 1. Unless noted otherwise, all specifications apply over the operating temperature

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 1. The all field domonstration board with impedance range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- 2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and
- external impedance matching design. See Application Note No. 42 for details. Part to part absolute delay measurement records the absolute delay mean
- across 1 dB passband.
- "LRIP" or "L" after the part number indicates "low rate initial production" and 5. "ENG" or "E" indicates "engineering prototypes."
- The design, manufacturing process, and specifications of this filter are subject to change.
- Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit

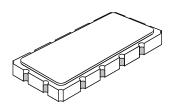
SF1177A-121604

- US and international patents may apply.
 Electrostatic Sensitive Device. Observe precautions for handling.



SM13365-12 Case

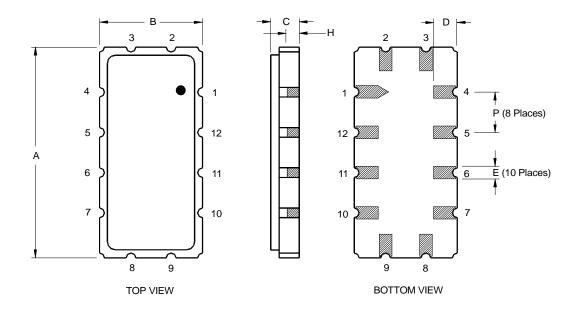
12-Terminal Ceramic Surface-Mount Case 13.3 x 6.5 mm Nominal Footprint



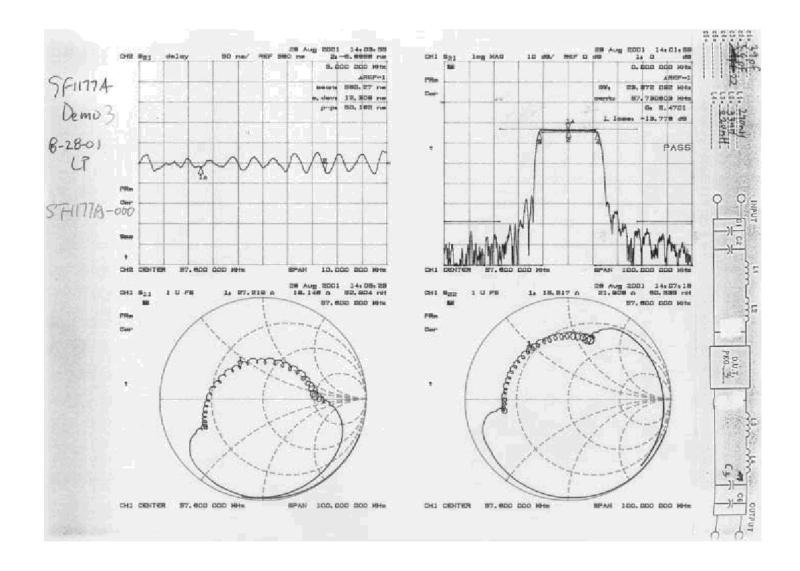
| Case Dimensions | | | | | | |
|-----------------|-------|-------|-------|--------|-------|-------|
| Dimension | mm | | | Inches | | |
| Dilliension | Min | Nom | Max | Min | Nom | Max |
| Α | 13.08 | 13.31 | 13.60 | 0.515 | 0.524 | 0.535 |
| В | 6.27 | 6.50 | 6.80 | 0.247 | 0.256 | 0.268 |
| С | | 1.91 | 2.00 | | 0.075 | 0.079 |
| D | | 1.50 | | | 0.059 | |
| E | | 0.79 | | | 0.031 | |
| Н | | 1.0 | | | 0.039 | |
| Р | | 2.54 | | | 0.100 | |

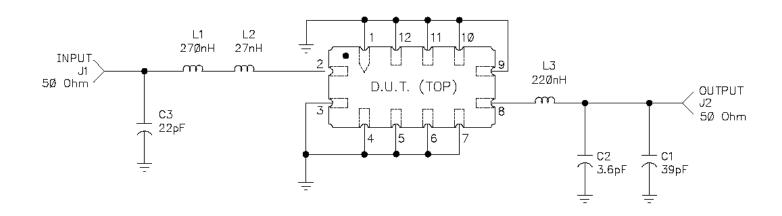
| Materials | | | | | |
|---------------------------|---|--|--|--|--|
| Solder Pad Termination | Au plating 30 - 60 ulnches (76.2-152 uM) over 80- 200 ulnches (203-508 uM) Ni. | | | | |
| Lid | Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick | | | | |
| Body | Al ₂ O ₃ Ceramic | | | | |
| Pb Free | | | | | |

| Electrical Connections | | | | |
|------------------------|------------------|------------------|--|--|
| | Connection | Terminals | | |
| Port 1 | Input or Return | 2 | | |
| | Return or Input | 3 | | |
| Port 2 | Output or Return | 8 | | |
| | Return or Output | 9 | | |
| | Ground | All others | | |
| Single Ended Operation | | Return is ground | | |
| Differe | ntial Operation | Return is hot | | |



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NOTES:

- 1. SOLDER MOUNT COMPONENTS & CONNECTORS TO PCB1.
- 2. ORIENT THE FLTR1 AND SOLDER IT DOWN TO THE BOARD AS SHOWN.

